

Forward-Endcap - Activities at Bonn -

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Helmholtz Institut für Strahlen- und Kernphysik



Outline



Production

- inserts, mountplates, interfaces
- alveoles

Photo sensor - VPTT

- test measurements
- teststation magnet

Cabeling

- cables photo detector
- patch panel PCB

Teststation

current status

Status production - Inserts, Mountplates, Interfaces



Inserts:

- 500 of 1000 produced
- estimated completion time may 2014

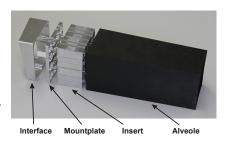
Mountplates:

- 219x 16er and 61x 8er on stock (214x 16er, 54x 8er)
- final "polishing" pending (vibratory grinding)

Interfaces:

- 161x pre-processed (3axis)
- final machining pending on 5axis last changes:
 - manipulator holes
 - due to alveole assembly

Drawings need to be finalized by KVI.



Endcap detector-submodule



Capsule (Bonn)



- guide for glueing
- isolation of preamp heat
- nylon after 1000Gy
 → no problem visible
- will be ordered

Wrapping foil (Bochum)



- laser precut
 - \rightarrow easy+precise folding
- will be ordered

Production - Alveoles



Prototype - alveoles:

- front open
- crystal position fixed by small carbon bracket
 - → Drawbacks:
 - inhomogeneous
 - further glueing step

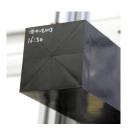
closed front with 0.18mm carbon

ightarrow more care about crystal position

Important issues before production:

- · front face wrapping procedure
- front face → edge rigidity
- fit of assembly inside alveole
- check fitting and dimensions due to new mold for higher production speed (120°C backing temp.)





Production - Alveoles



New mold was manufactured by fibreworx and delivered pre-production samples:

1st batch:

inserts get stuck to early → play in front (1-2mm)

2nd batch:

changes: mold shortened by 0.5mm

- result in good fit of insert,
- problems with rigidity of edges

3rd batch:

- improved tooling for post-processing
- front face has $0^{\circ}/90^{\circ}$ and $45^{\circ}/45^{\circ}$ carbon layer
 - → improved edge rigidity
- prepreg cuted by cnc → minimizes wrinkeling



achieved wanted results \rightarrow final production can start.

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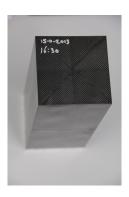
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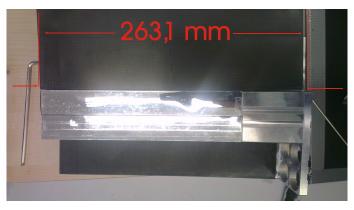


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Endcap detector-submodule



Test assemblies:



Important issue:

- after production of parts and assembly \rightarrow submodul must stay in limits

Detector-submodule assembly



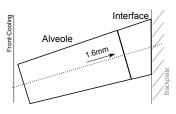
Length

Measured length versus CAD

- pprox 263.1mm ightarrow 261.6mm
- → 1.5mm too long (carbon+foil+capsule+play)

2mm play forseen, to get back 2mm play again

ightarrow slight modifications to the interface forseen



Centering

First tests done w/o glueing the insert.

ightarrow measured variation pprox 0.5mm

Forseen space between submodules 1mm.

Assembly tools needed

 \rightarrow guiding the alveole during glueing

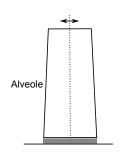
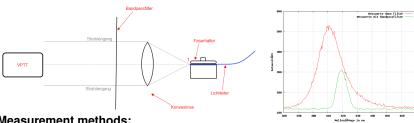




Photo detector readout chain (LNP+Shaping) is used. LED-Pulser tuned to be close to scintilation light (selected LED+bandpass filter).

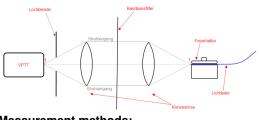


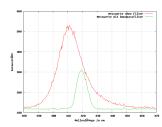
Measurement methods:

integral - complete tube illuminated



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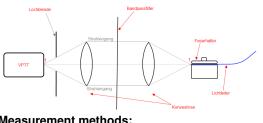
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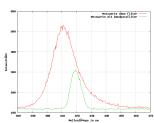
- integral complete tube illuminated
- surface scan

VPTT - teststation at Bonn



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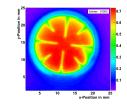


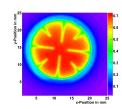


Measurement methods:

- integral complete tube illuminated
- surface scan





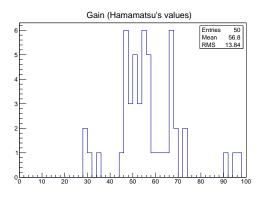




Measurements with pre-production run of 50 VPTTs done at Bochum and Bonn

Available parameters:

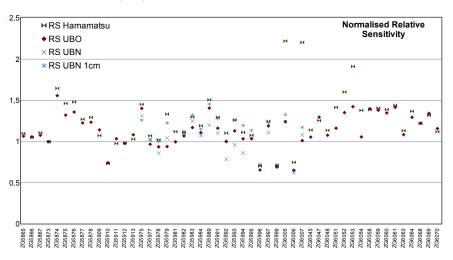
- Hamamatsu: gain, blue sens. (QEb)
- teststation@Bochum: gain (ratio of measured currents)
- teststation@Bonn: gain * blue sens. (QEb) * area (relative to PM)



VPTT - cross check of Hamamatsu's values



Measurements with pre-production run of 50 VPTTs done at Bochum and Bonn

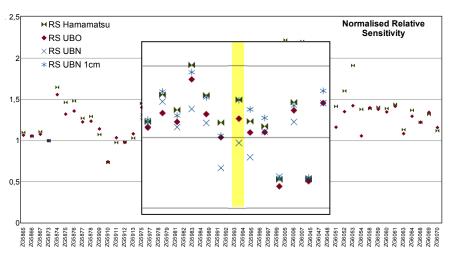


RS = Ratio of (Gain * QEb) to ref. VPTT (Gain * QEb)

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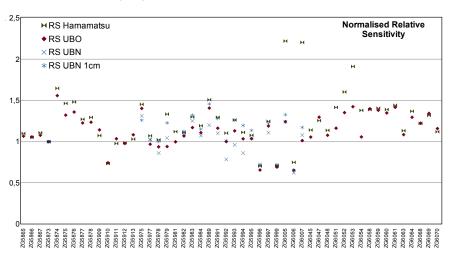


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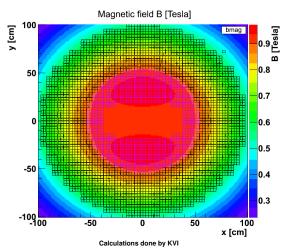
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Magnitude of the magnetic field at the position of the VPTTs. Simulation done for a 2T-field.

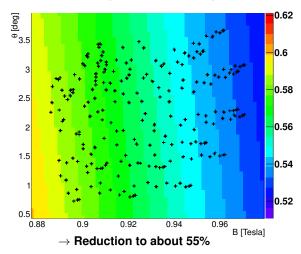


→ VPTTs will see a field strength of about 0.8-1T

VPTT - magnet field impact



Relative gain for all VPTTs at angle and field strength

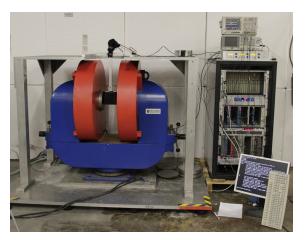


Based on B-field measurements @Bochum ($\theta=0^{\circ},\,6^{\circ}$). ϕ -dependence \approx 5%

Teststation - magnet (Bonn)



Setup for testing VPTTs in magnetic field NOW operational

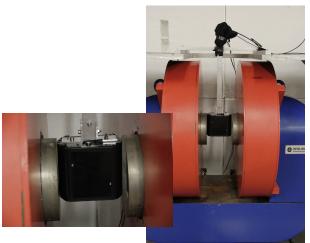


Properties:

rotatable 360°, normal conducting, fields: 1.2T@16cm gap, 2T@6cm gap



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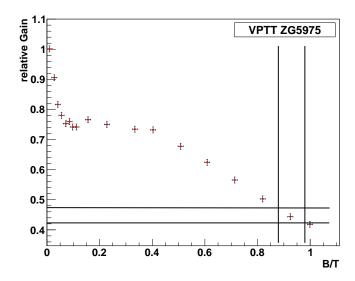
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Teststation - magnet first measurement



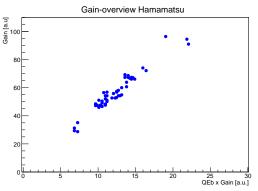
VPTT ZG5975 @750V in magnetic field





CERN test-measurement:

S/N as good as APDs ightarrow gain > 24 ightarrow x2 (B-field reduction) ightarrow gain > 48



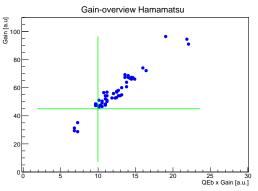
Next 100 VPTTs ordered:

- wish: Gain > 45, QEb * Gain > 10
- Hamamatsu agreed on Gain > 30, Skb > 8
- to allow Hamamatsu to get more experience in production process



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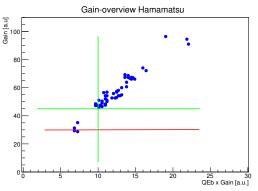
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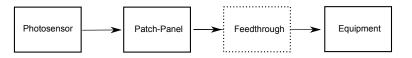


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Cabeling inner part of endcap





Sections:

- photo sensor cable set
- patch-panel PCB
- cables connecting patch-panel PCB to endcap borderline (LV/HV-cables, sensor-cables, signal-cables)
- feed-throughs

Photosensor cable set:

- Signal cable UFL-plug + 1,3mm coax (≈ 15cm)
- ground lead (≈ 5-10cm)
- 3x Low voltage cable AWG26 (≈ 15cm)
- 2-3x High voltage cable AWG22 (≈ 15cm)

Patch-panel PCB - Overview



Logical structure:

- All plugs for one compartement in each corner
- cuttable in the middle for 8er alveoles
- all HVs patched to panel APD: 32; VPTT: 16

HV-plug: 4x GND, 4x/8x HV \rightarrow 12pin

- 4x sensor
- 32x UFLs (VPTT: only every 2nd used)
- LV: 3pin plug/photo detector

PCB:

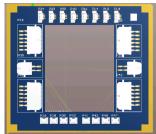
- 4 or 6 layer board
- tested LV alternatives
- no real alternative for HV found

total height: \approx 1cm to 1.5cm

top:



bottom:



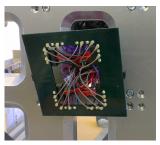
Patch-panel PCB - Mounting



Mounting procedure:

- · connecting voltage cables
- screwing PCB to backplate (spacer)
- connecting signal and sensor cables
- add clamp for UFL-plugs





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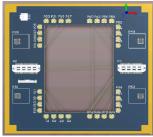
Patch-panel PCB - Next steps



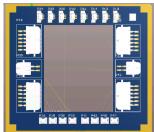
Next steps / current work:

- finalize part positioning
- do electrical routing (impedance matching) with help of pcb manafacturer
- build prototype for testing
- finalize ordering cable-set photo-sensor

top:



bottom:



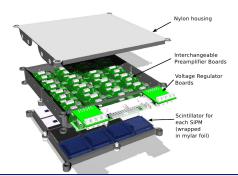


- 2 climate chambers installed (control system setup)
- ullet Trigger detector developed o will be built in the next month
- Data aquisition in setup phase
- Mechanical parts in progress





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Thank you for your attention